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May 2007

74VHC4040
12-Stage Binary Counter

Features

- High speed; f_{MAX} = 210MHz at V_{CC} = 5V
- Low power dissipation: I_{CC} = 4μA (Max.) at T_A = 25°C
- High noise immunity: $V_{NIH} = V_{NIL}$ = 28% V_{CC} (Min.)
- Power down protection is provided on all inputs
- Wide operating voltage range: V_{CC} (Opr.) = 2V – 5.5V
- Low noise: V_{OLP} = 0.8V (Max.)
- Pin and function compatible with 74HC4040

General Description

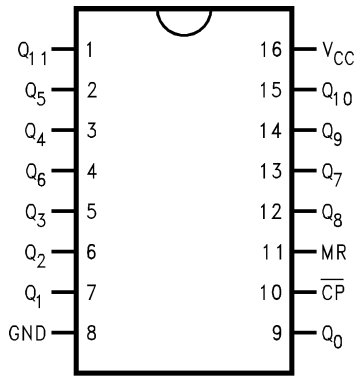
The VHC4040 is an advanced high-speed CMOS device fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The VHC4040 is a 12-stage counter which increments on the negative edge of the input clock and all outputs are reset to a low level by applying a logical high on the reset input. An input protection circuit insures that 0V to 7V can be applied to the inputs without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

Ordering Information

Order Number	Package Number	Package Description
74VHC4040M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC4040MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering number.

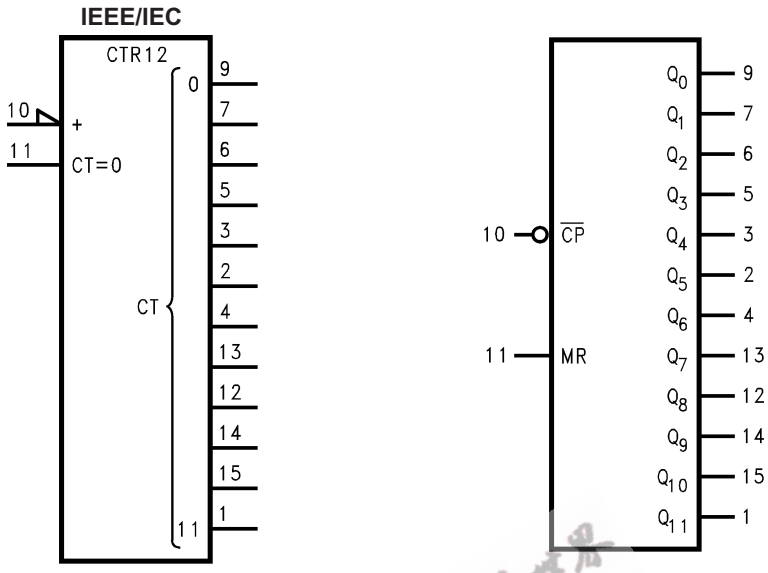
Connection Diagram



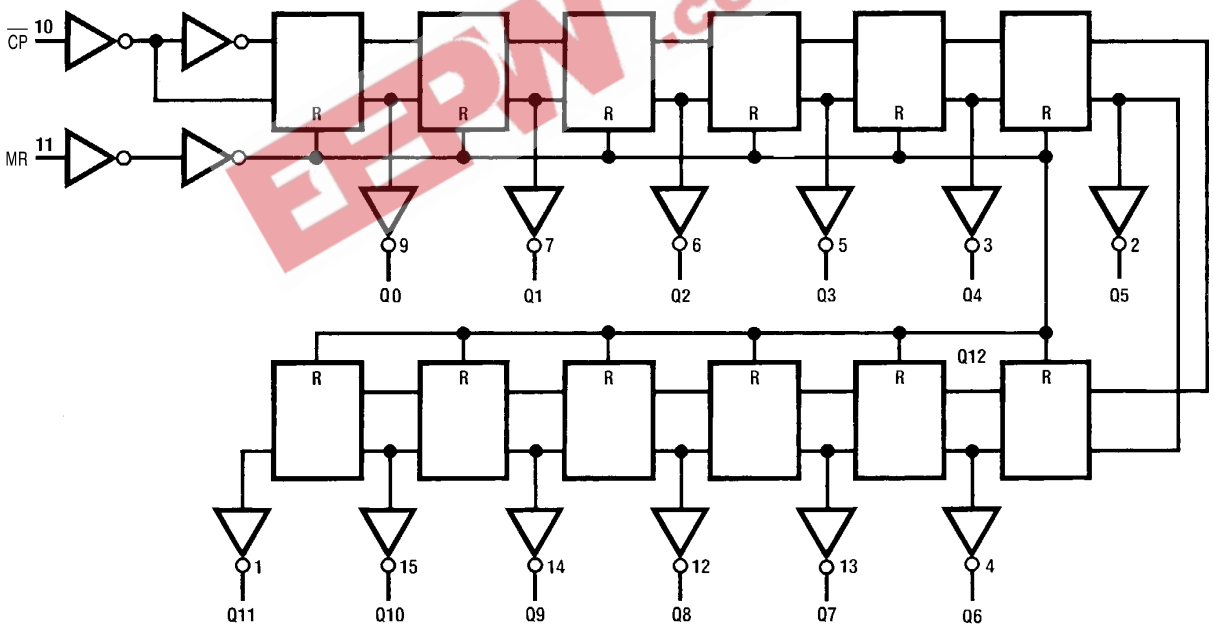
Pin Descriptions

Pin Names	Description
Q_0–Q_{11}	Flip-Flop Outputs
$\overline{CP}$	Negative Edged Triggered Clock
MR	Master Reset

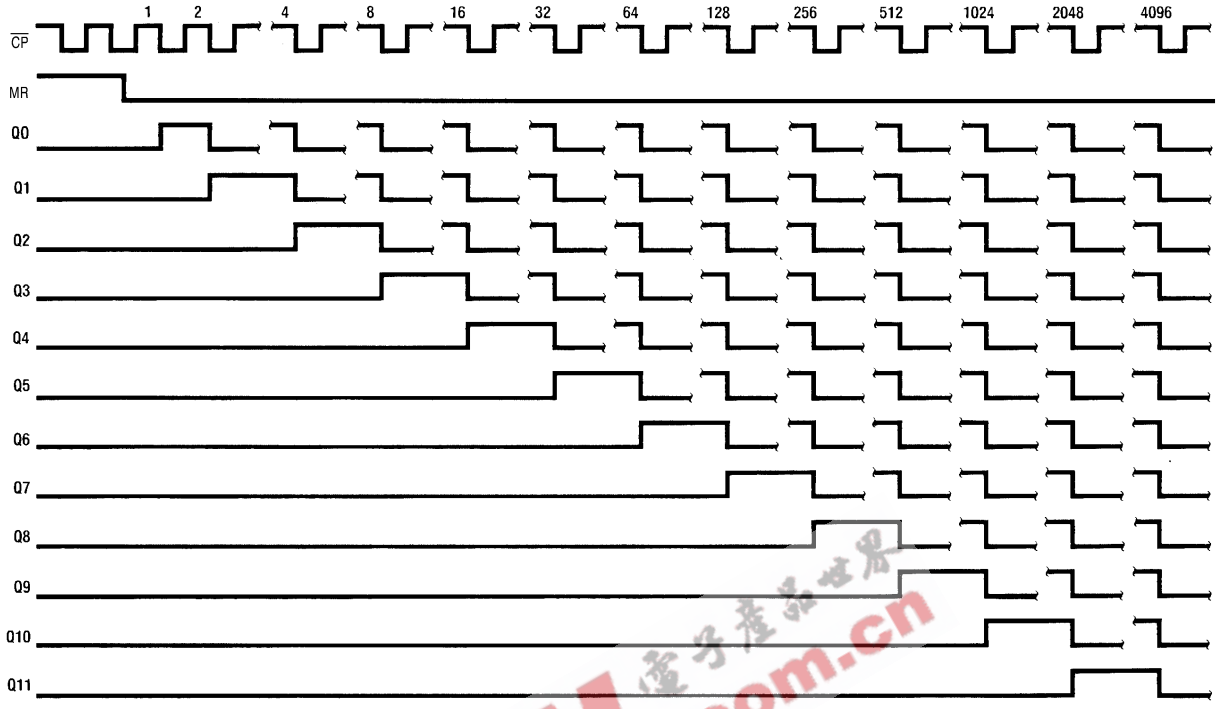
Logic Symbols



Logic Diagram



Timing Diagram



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	–0.5V to +7.0V
V_{IN}	DC Input Voltage	–0.5V to +7.0V
V_{OUT}	DC Output Voltage	–0.5V to V_{CC} + 0.5V
I_{IK}	Input Diode Current	–20mA
I_{OK}	Output Diode Current	±20mA
I_{OUT}	DC Output Current	±25mA
I_{CC}	DC V_{CC} / GND Current	±75mA
T_{STG}	Storage Temperature	–65°C to +150°C
T_L	Lead Temperature (Soldering, 10 seconds)	260°C

Recommended Operating Conditions[1]

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	2.0V to +5.5V
V_{IN}	Input Voltage	0V to +5.5V
V_{OUT}	Output Voltage	0V to V_{CC}
T_{OPR}	Operating Temperature	–40°C to +85°C
t_r, t_f	Input Rise and Fall Time	
	V_{CC} = 3.3V ±0.3V	0 ~ 100ns/V
	V_{CC} = 5.0V ±0.5V	0 ~ 20ns/V

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	Conditions		T_A = 25°C			T_A = –40°C to +85°C		Units
					Min.	Typ.	Max.	Min.	Max.	
V_{IH}	HIGH Level Input Voltage	2.0			1.50			1.50		V
		3.0 – 5.5			0.7 x V_{CC}			0.7 x V_{CC}		
V_{IL}	LOW Level Input Voltage	2.0					0.50		0.50	V
		3.0 – 5.5					0.3 x V_{CC}		0.3 x V_{CC}	
V_{OH}	HIGH Level Output Voltage	2.0	V_{IN} = V_{IH} or V_{IL}	I_{OH} = –50µA	1.9	2.0		1.9		V
		3.0			2.9	3.0		2.9		
		4.5			4.4	4.5		4.4		
		3.0		I_{OH} = –4mA	2.58			2.48		
		4.5		I_{OH} = –8mA	3.94			3.80		
V_{OL}	LOW Level Output Voltage	2.0	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50µA		0.0	0.1		0.1	V
		3.0				0.0	0.1		0.1	
		4.5				0.0	0.1		0.1	
		3.0		I_{OL} = 4mA			0.36		0.44	
		4.5		I_{OL} = 8mA			0.36		0.44	
I_{IN}	Input Leakage Current	0 – 5.5	V_{IN} = 5.5V or GND				±0.1		±1.0	µA
I_{CC}	Quiescent Supply Current	5.5	V_{IN} = V_{CC} or GND				4.0		40.0	µA

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	Conditions	T_A = +25°C			T_A = –40°C to +85°C		Units
				Min.	Typ.	Max.	Min.	Max.	
t_{PLH}, t_{PHL}	Propagation Delay Time to Q_1	3.3 ± 0.3	C_L = 15pF		7.5	11.9	1.0	14.0	ns
			C_L = 50pF		10.0	15.4	1.0	17.5	
		5.0 ± 0.5	C_L = 15pF		4.8	7.3	1.0	8.5	ns
			C_L = 50pF		6.3	9.3	1.0	10.5	
t_{PLH}, t_{PHL}	Propagation Delay Time between Stages from Q_n to Q_{n+1}	3.3 ± 0.3	C_L = 15pF						ns
			C_L = 50pF		2.4	4.4	1.0	5.0	
		5.0 ± 0.5	C_L = 15pF						ns
			C_L = 50pF		1.6	3.1	1.0	3.5	
t_{PHL}	Propagation Delay Time MR–Q_n	3.3 ± 0.3	C_L = 15pF		8.3	12.8	1.0	15.0	ns
			C_L = 50pF		10.8	16.3	1.0	18.5	
		5.0 ± 0.5	C_L = 15pF		5.6	8.6	1.0	10.0	ns
			C_L = 50pF		7.1	10.6	1.0	12.0	
f_{MAX}	Maximum Clock Frequency	3.3 ± 0.3	C_L = 15pF	90	140		75		MHz
			C_L = 50pF	55	80		50		
		5.0 ± 0.5	C_L = 15pF	150	210		125		MHz
			C_L = 50pF	95	125		80		
C_{IN}	Input Capacitance		V_{CC} = Open		4	10		10	pF
C_{PD}	Power Dissipation Capacitance		(2)		21				pF

Note:

2. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:
   I_{CC} (Opr.) = C_{PD} • V_{CC} • f_N + I_{CC}

AC Operating Requirements

Symbol	Parameter	V_{CC} (V)	T_A = 25°C		T_A = –40°C to +85°C	Units
			Typ.	Guaranteed Minimum		
t_w(L), t_w(H)	Minimum Pulse Width ($\overline{CP}$)	3.3 ± 0.3		5.0	5.0	ns
		5.0 ± 0.5		5.0	5.0	
t_w(L)	Minimum Pulse Width (MR)	3.3 ± 0.3		5.0	5.0	ns
		5.0 ± 0.5		5.0	5.0	
t_{REC}	Minimum Removal Time (MR)	3.3 ± 0.3		5.0	5.0	ns
		5.0 ± 0.5		5.0	5.0	

Physical Dimensions

Dimensions are in millimeters unless otherwise noted.

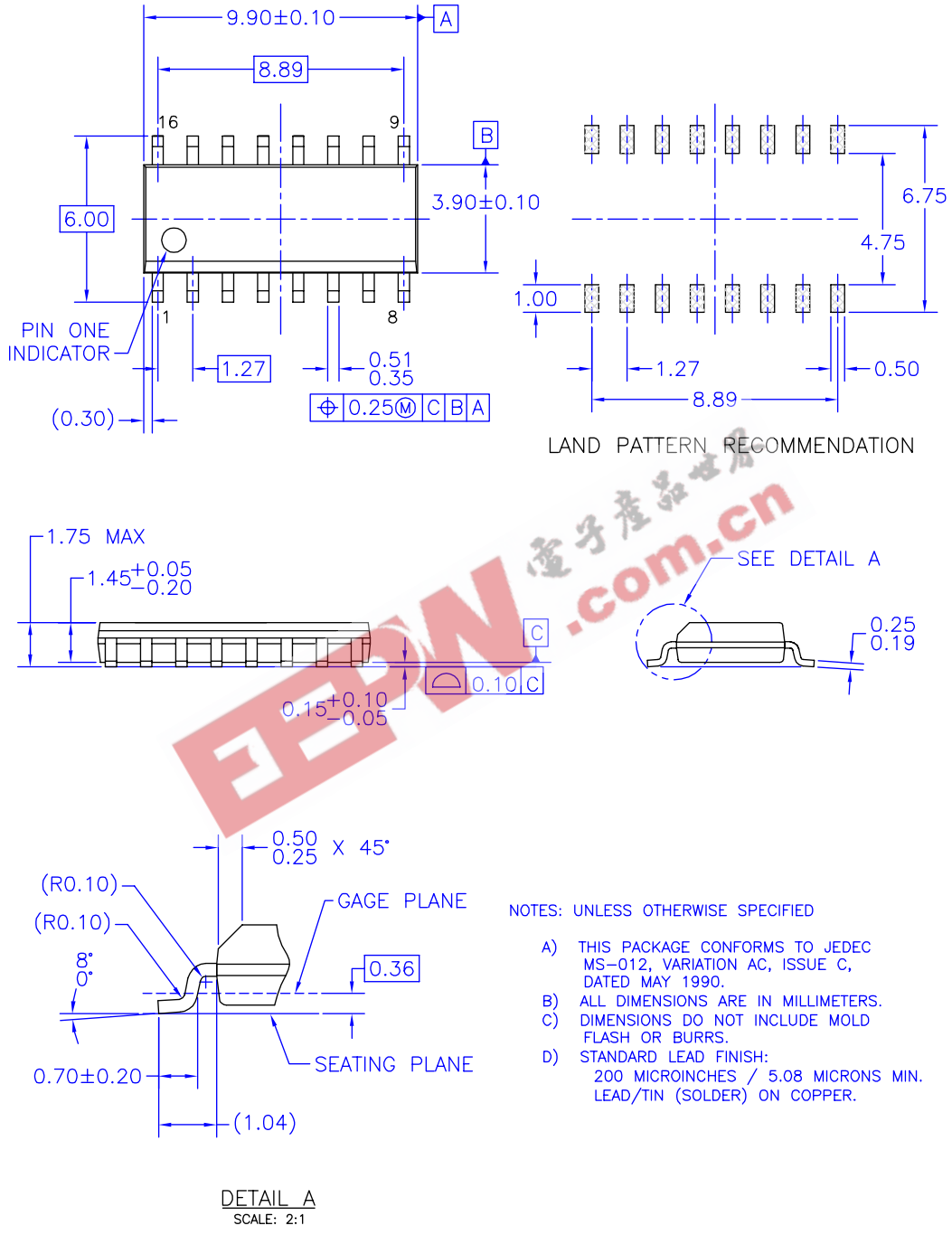
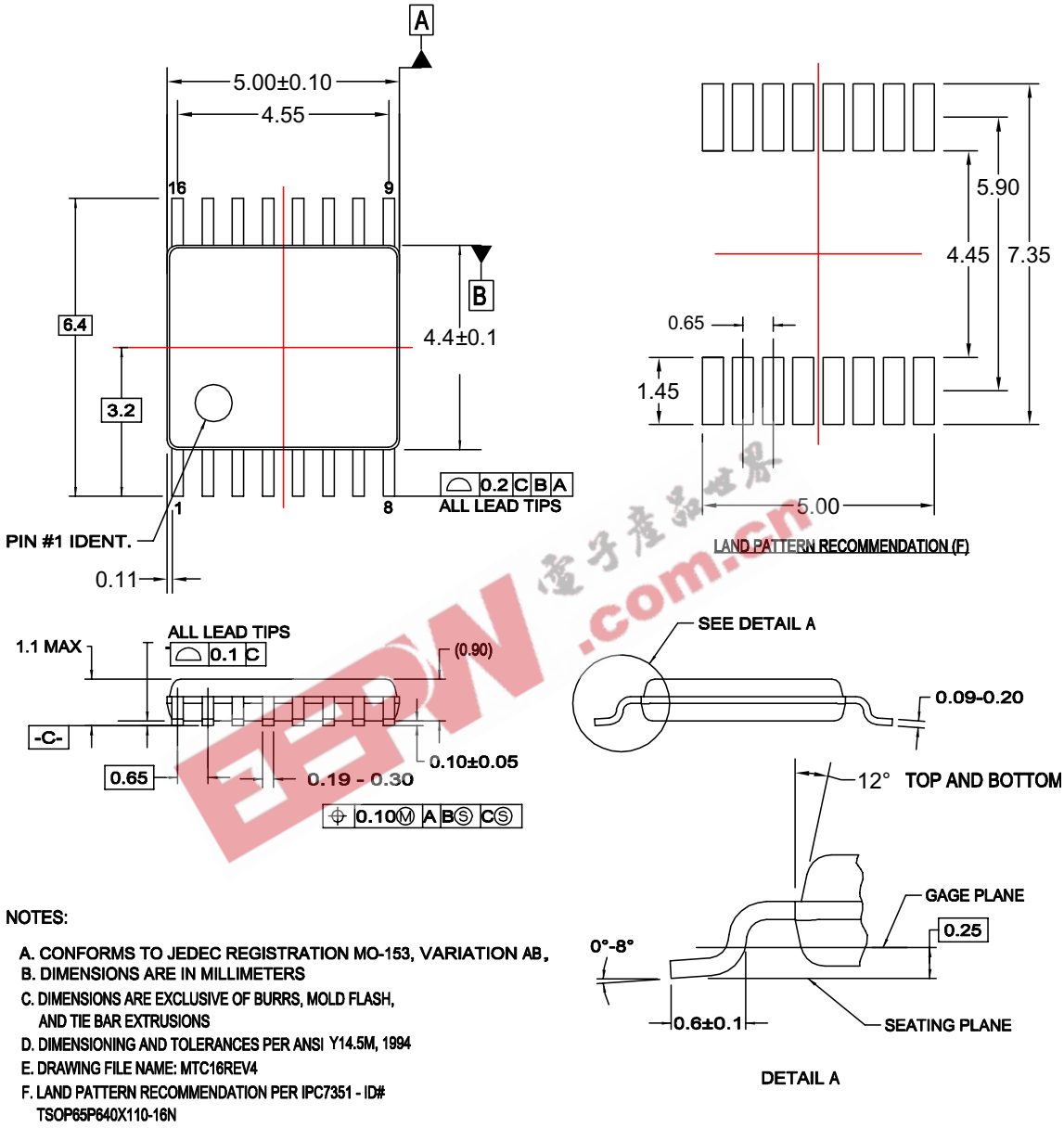


Figure 1. 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M16A

Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.



NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB,
B. DIMENSIONS ARE IN MILLIMETERS
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1994
E. DRAWING FILE NAME: MTC16REV4
F. LAND PATTERN RECOMMENDATION PER IPC7351 - ID# TSOP65P640X110-16N

MTC16rev4

Figure 2. 16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC16

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